
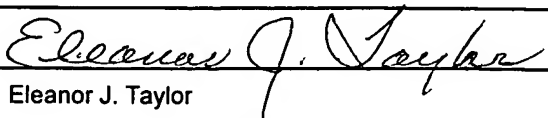


PTO TRANSMITTAL FORM (to be used for all correspondence after initial filing) Total Number of Pages in This Submission	Application Number	10751,265
	Filing Date	January 2, 2004
	First Named Inventor	Yilmaz, Hamza
	Art Unit	2811
	Examiner Name	Thien F. Tran
	Attorney Docket Number	020964-003900US

ENCLOSURES (Check all that apply)		
<input type="checkbox"/> Fee Transmittal Form	<input checked="" type="checkbox"/> Drawing(s)	<input type="checkbox"/> After Allowance Communication to TC
<input type="checkbox"/> Fee Attached	<input type="checkbox"/> Licensing-related Papers	<input type="checkbox"/> Appeal Communication to Board of Appeals and Interferences
<input checked="" type="checkbox"/> Amendment/Reply	<input type="checkbox"/> Petition	<input type="checkbox"/> Appeal Communication to TC (Appeal Notice, Brief, Reply Brief)
<input type="checkbox"/> After Final	<input type="checkbox"/> Petition to Convert to a Provisional Application	<input type="checkbox"/> Proprietary Information
<input type="checkbox"/> Affidavits/declaration(s)	<input type="checkbox"/> Power of Attorney, Revocation Change of Correspondence Address	<input type="checkbox"/> Status Letter
<input checked="" type="checkbox"/> Extension of Time Request	<input type="checkbox"/> Terminal Disclaimer	<input checked="" type="checkbox"/> Other Enclosure(s) (please identify below):
<input type="checkbox"/> Express Abandonment Request	<input type="checkbox"/> Request for Refund	•Return Postcard
<input type="checkbox"/> Information Disclosure Statement	<input type="checkbox"/> CD, Number of CD(s) _____	•Communication to Submit Replacement Drawings
	<input type="checkbox"/> Landscape Table on CD	•Submission of Reference to Be Placed in File Pursuant to 37 CFR 3.97(h)(8)
<input type="checkbox"/> Certified Copy of Priority Document(s)	Remarks	•Reference: Appendix B Electrochemical Etching of Thick Copper Patterns on Circuit Substrate
<input type="checkbox"/> Reply to Missing Parts/ Incomplete Application	The Commissioner is authorized to charge any additional fees to Deposit Account 20-1430.	
<input type="checkbox"/> Reply to Missing Parts under 37 CFR 1.52 or 1.53		

SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT			
Firm Name	Townsend and Townsend and Crew LLP		
Signature			
Printed name	Kent J. Tobin		
Date	May 8, 2006	Reg. No.	39,496

CERTIFICATE OF TRANSMISSION/MAILING			
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On May 8, 2006

TOWNSEND and TOWNSEND and CREW LLP

By: Eleanor J. Taylor

PATENT

Docket No.: 020964-003900US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

HAMZA YILMAZ et al.

Application No.: 10/751,265

Filed: January 2, 2004

For: SEMICONDUCTOR DEVICE
PACKAGE DIEPAD HAVING
FEATURES FORMED BY
ELECTROPLATING

Customer No.: 20350

Confirmation No.: 7450

Examiner: Thien F. Tran

Art Unit: 2811

**COMMUNICATION TO SUBMIT
REPLACEMENT DRAWINGS**

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Please make the enclosed eighteen (18) sheets of replacement drawings (Figs. 1A, 1B, 1C, 1D, 1E, 1F, 1G, 1H, 2, 3A, 3AA, 3B, 3BA, 3C, 3CA, 3D, 3DA, 3E, 3EA, 4, 5, 5A, 5AA, 5B, 5BA, 5C, 5CA, 5D, 5DA, 5E, 5EA, 5F, 5FA, 5G, 5H, 5I, 5J, 5K, 6, 7, 7A, 7B, 7C, 7D, 7E, 7F, 7G, 7H, 8, 9A, 9B, 9C, 10A, 10B, 10C, 11, 12, 13A, 13B) of record in the above-identified patent application. These drawings replace those filed with the application on January 2, 2004 and no new matter has been added.

Respectfully submitted,

Kent J. Tobin
Reg. No. 39,496

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60767927 v1



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PATENT
Docket No.: 020964-003900US

On May 8, 2006

TOWNSEND and TOWNSEND and CREW LLP

By: Eleanor J. Taylor

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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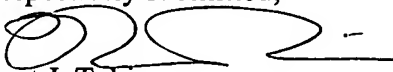
SUBMISSION OF REFERENCE
TO BE PLACED IN FILE
PURSUANT TO 37 CFR 1.97(h)(i)

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Pursuant to 37 CFR 1.97(h)(i), Applicants respectfully request that the following reference: "APPENDIX B Electrochemical Etching of Thick Copper Patterns on Circuit Substrate", a copy of which is enclosed herewith, be placed into the file of the instant application.

Respectfully submitted,


Kent J. Tobin
Reg. No. 39,496

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